ASSOCIATION CONNECTING LECTRONICS INDUSTRIES INDUSTRIES	C. Bannockt	ourn. Illinois. A	ll rights reserved utions.	under both This d	ocumer parts, th	nt is a declaration le declaration en	on of the su compasses	ibstances s all lowe	within the manufact r level materials for	urer listed which the	item. Note manufactur	: if the item is an a rer has engineering	assembly with lower g responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distri				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					rials and I	s and Mfg Information			
Supplier Information														
Company name*		Company unique ID			U	Unique ID Authority					Response Date*			
onsemi										2024-0	2024-04-25			
Contact Name	tet Name Title - Contact]		Phone - Contact*				Email	Email - Contact*			
roduct-Env-Stewards Product Env			nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Rep			- Representative			Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance			N	NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number	Mfr Item Name]	Effective Date	Version	1	Manufacturing Site		Weight*	UOM	Unit Type	
	NCV815 TBG			l 300 mA, Low IQ, LDO, wettable flanks		2024-04-25		1	MY1		23.85	mg	Each	
Manufacturing Proccess Informati	on													
Terminal Plating / Grid Array Mate	inal Plating / Grid Array Material Terminal Base A		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature		e Max Time at Pea	k Temper	ature Nur	nber of Reflow C	vcles		
Matte Tin (Sn) - annealed CU Alloy			1		260	С		30	seco	onds 3				
Comments														
evel 1 - maximum time at peak temperatur	e during sol	Idering is 10-3	0 seconds											
for more information regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth					
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.01	mg	Supplier	Silicon (Si)	7440-21-3		1.01	mg
Die Attach	0.12	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0072	mg
			Supplier	Silver (Ag)	7440-22-4		0.0978	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0072	mg
			Supplier	Misc.	Proprietary Data		0.0006	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0072	mg
Lead Frame	7.06	mg	Supplier	Tin (Sn)	7440-31-5		0.0176	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0155	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0176	mg
			Supplier	Copper (Cu)	7440-50-8		7.0092	mg
ead Frame plating	0.14	mg	Supplier	Silver (Ag)	7440-22-4		0.14	mg
Mold Compound-Black	14.2	mg		Epoxy resin	proprietary data		0.6674	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.42	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0142	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.431	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.6674	mg
Plating	1.1	mg	Supplier	Tin (Sn)	7440-31-5		1.1	mg
Wire Bond - Au	0.22	mg	Supplier	Gold (Au)	7440-57-5		0.22	mg